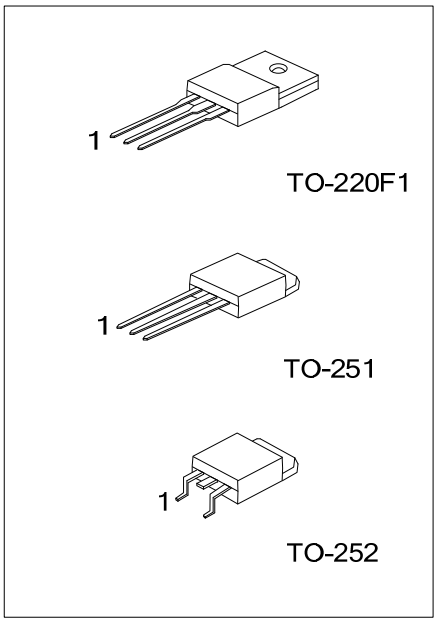
2NM70-QFD

Power MOSFET

2A, 700V N-CHANNEL SUPER-JUNCTION MOSFET



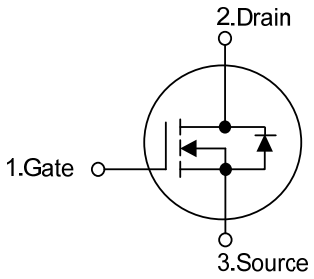
■ DESCRIPTION

The **UTC 2NM70-QFD** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

■ FEATURES

* $R_{DS(ON)}$ < 4.0Ω @ V_{GS} = 10V, I_D =1.0A
* Fast switching capability
* Avalanche energy specified
* Improved dv/dt capability, high ruggedness

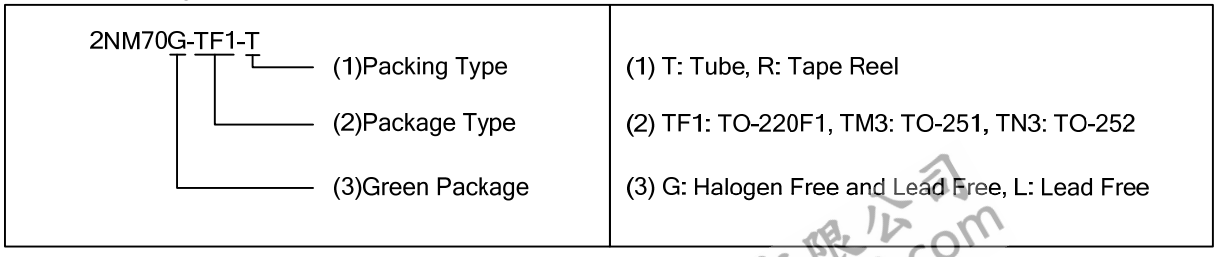
■ SYMBOL



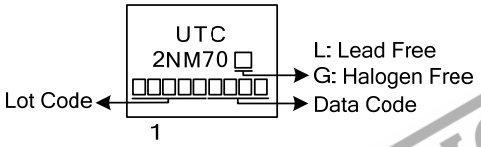
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
2NM70L-TF1-T	2NM70G-TF1-T	TO-220F1	G	D	S	Tube
2NM70L-TM3-T	2NM70G-TM3-T	TO-251	G	D	S	Tube
2NM70L-TN3-R	2NM70G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source



■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	700	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous	I_D	2	A
	Pulsed (Note 2)	I_{DM}	6	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	13	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	10	V/ns
Power Dissipation	TO-220F1	P_D	28	W
	TO-251/TO-252		30	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. L=10mH, I_{AS}=1.6A, V_{DD}=50V, R_G=25 Ω, Starting T_J = 25°C
4. I_{SD}≤2.0A, di/dt≤200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

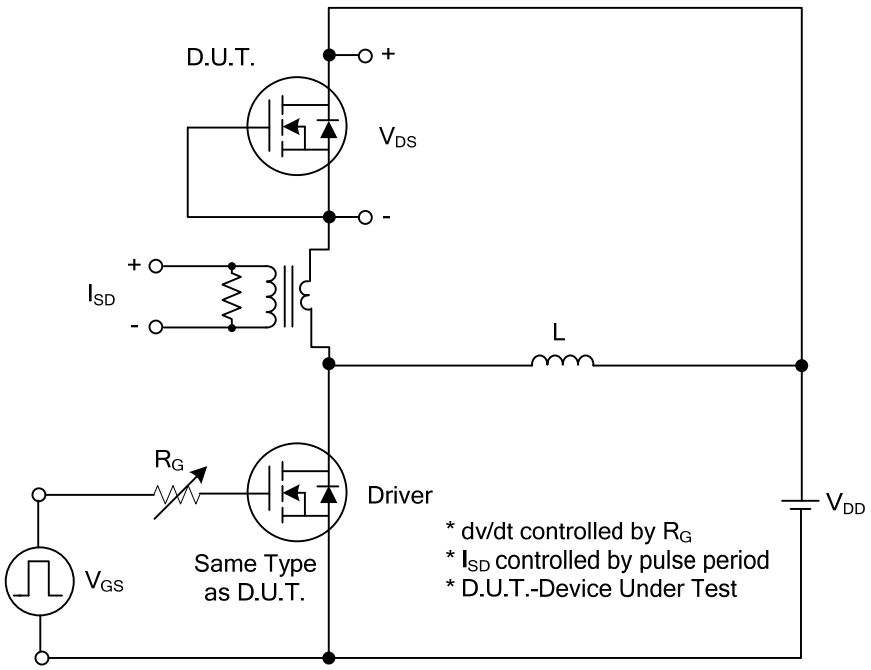
PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F1	θ_{JA}	62.5	°C/W
	TO-251/TO-252		110	°C/W
Junction to Case	TO-220F1	θ_{JC}	4.46	°C/W
	TO-251/TO-252		4.24	°C/W

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

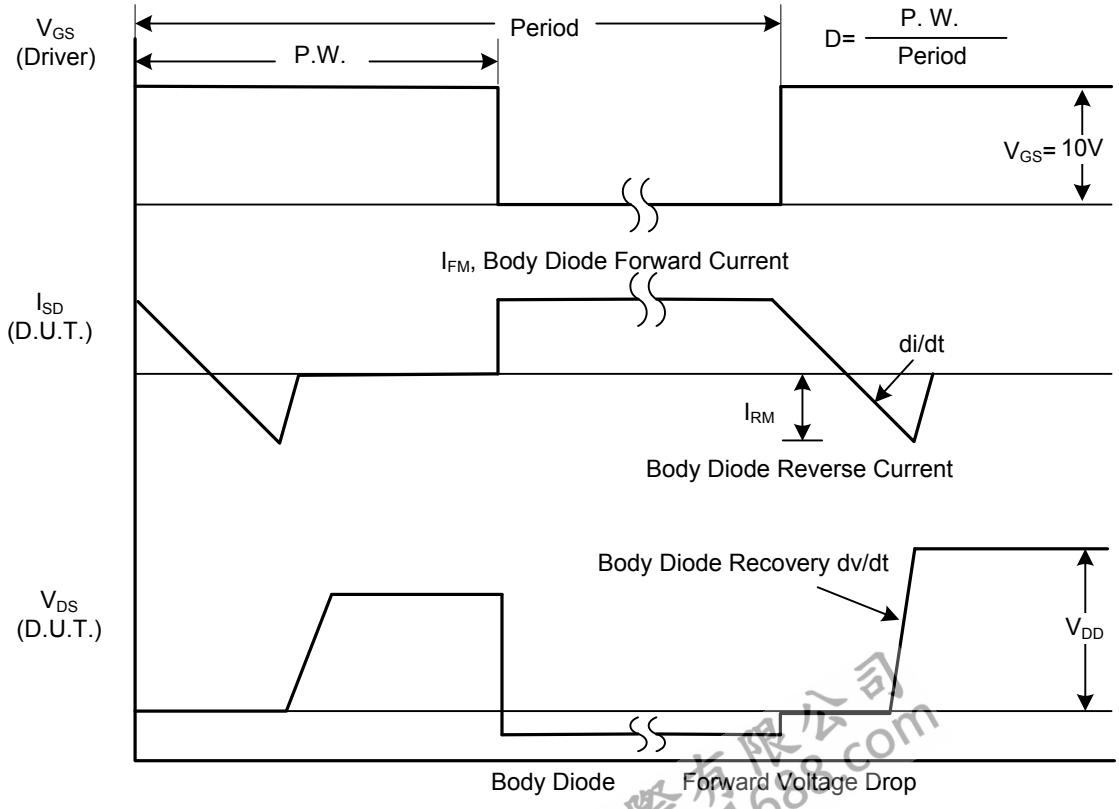
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS} = 0V, I_D = 250μA	700			V
Drain-Source Leakage Current		I_{DSS}	V_{DS} = 700V, V_{GS} = 0V			10	μA
Gate-Source Leakage Current	Forward	I_{GSS}	V_{GS} = 30V, V_{DS} = 0V			100	nA
	Reverse		V_{GS} = -30V, V_{DS} = 0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS} = V_{GS}, I_D = 250μA	2.5		4.5	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS} = 10V, I_D =1.0A			4.0	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C_{ISS}	V_{DS} =25V, V_{GS} =0V, f =1MHz		130		pF
Output Capacitance		C_{OSS}			90		pF
Reverse Transfer Capacitance		C_{RSS}			10		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge		Q_G	V_{DS}=200V, V_{GS}=10V, I_D=2A I_G=3mA (Note 1, 2)		12		nC
Gate-Source Charge		Q_{GS}			4.5		nC
Gate-Drain Charge		Q_{GD}			3.6		nC
Turn-On Delay Time		$t_{D(ON)}$	V_{DD}=100V, V_{GS}=10V, I_D =2A, R_G =25Ω (Note 1, 2)		1		ns
Turn-On Rise Time		t_R			3.8		ns
Turn-Off Delay Time		$t_{D(OFF)}$			16		ns
Turn-Off Fall Time		t_F			21		ns
DRAIN-SOURCE DIODE CHARACTERISTICS							
Continuous Drain-Source Current		I_S				2.0	A
Maximum Pulsed Drain-Source Diode Forward Current		I_{SM}				6.0	A
Drain-Source Diode Forward Voltage		V_{SD}	I_S=2.0A, V_{GS}=0V			1.4	V
Body Diode Reverse Recovery Time		t_{rr}	I_S=2.0A, V_{GS}=0V dI/dt=100A/μs		94		nS
Body Diode Reverse Recovery Charge		Q_{rr}			6.28		μC

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle≤2%.
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

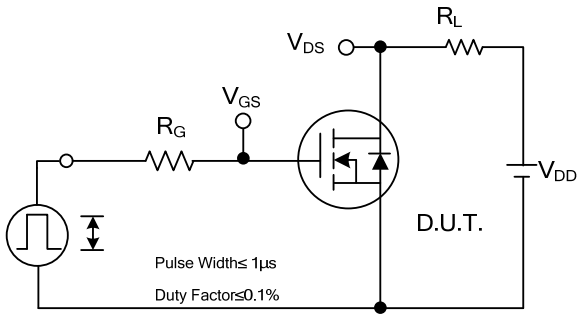


Peak Diode Recovery dv/dt Test Circuit

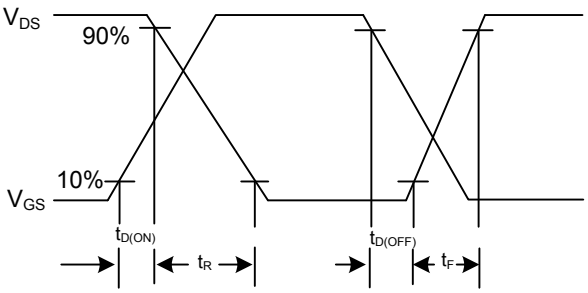


Peak Diode Recovery dv/dt Waveforms

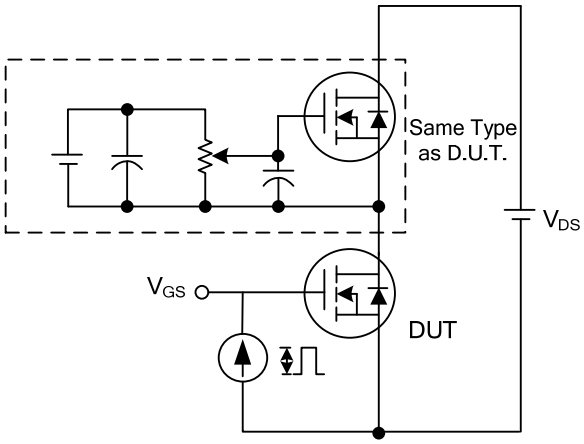
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



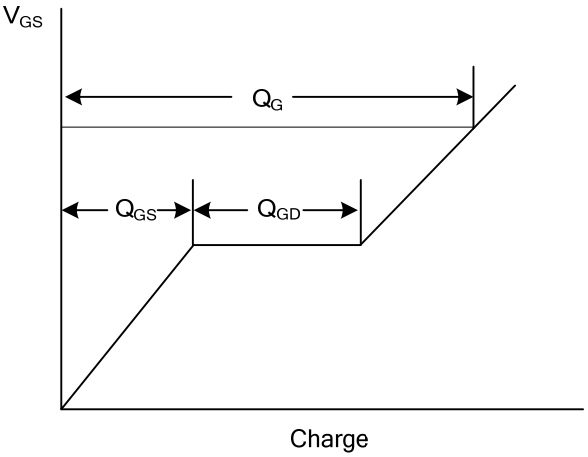
Switching Test Circuit



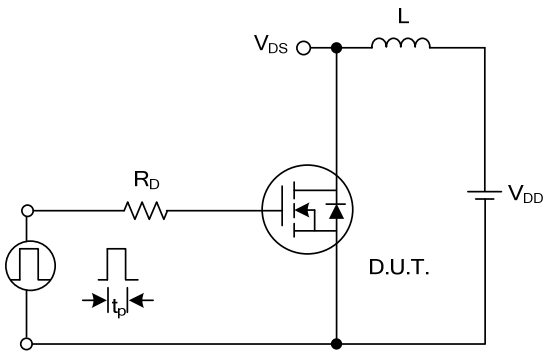
Switching Waveforms



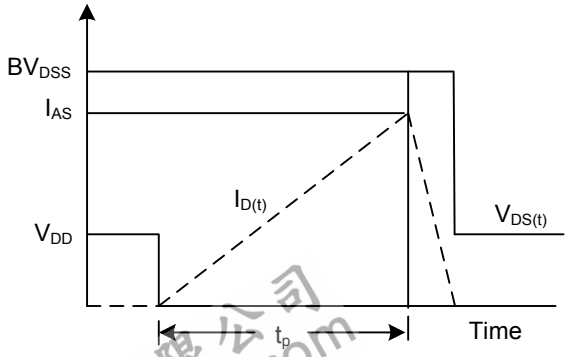
Gate Charge Test Circuit



Gate Charge Waveform



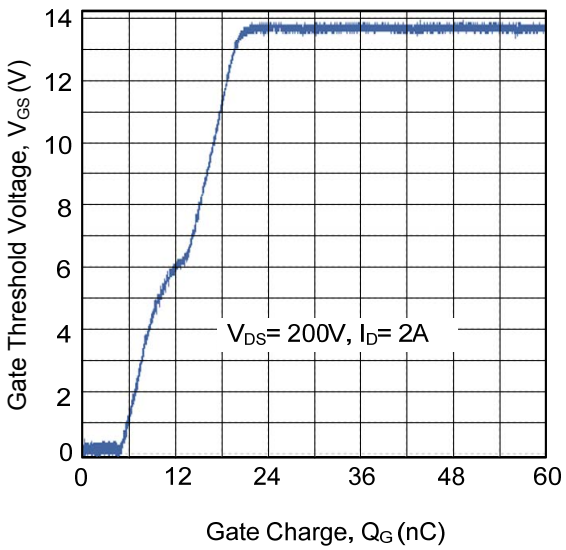
Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS

Gate Charge vs. Gate to Source Voltage



Capacitance Characteristics